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EPAS ID: PAT4823855

<b>SUBMISSION TYPE:</b>	CORRECTIVE ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	Corrective Assignment to correct the STREET ADDRESS OF THE ASSIGNEE previously recorded on Reel 032849 Frame 0694. Assignor(s) hereby confirms the AUF?M SHOULD READ AUF'M.
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
ULRICH WENDELN	05/06/2014
ULRICH MEYER	05/06/2014
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<b>Street Address:</b>	AUF'M HALSKAMP 12
<b>City:</b>	GARREL
<b>State/Country:</b>	GERMANY
<b>Postal Code:</b>	49681
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	14356980
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(212)588-0500
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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<b>Address Line 4:</b>	NEW YORK, NEW YORK 10151
<b>ATTORNEY DOCKET NUMBER:</b>	135428-2226
<b>NAME OF SUBMITTER:</b>	EUGENE LEDONNE
<b>SIGNATURE:</b>	/Eugene LeDonne/
<b>DATE SIGNED:</b>	02/14/2018
<b>Total Attachments: 5</b>	
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\*\* On the Notice of Recordation Auf'm is misspelled  
it should read Auf'm not Auf?m  
Please correct the spelling to read Auf'm.

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
ULRICH WENDELN	05/06/2014
ULRICH MEYER	05/06/2014
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SPC SUNFLOWER PLASTIC COMPOUND GMBH
<b>Street Address:</b>	AUF'M HALSKAMP 12
<b>City:</b>	GARREL
<b>State/Country:</b>	GERMANY
<b>Postal Code:</b>	48681
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	14356980
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(212)588-0800

is

Phone: (212) 588-0800 Email: mroopram@flhlaw.com <i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i> Correspondent Name: FROMMER LAWRENCE & HAUG Address Line 1: 745 FIFTH AVENUE- 10TH FL. Address Line 4: NEW YORK, NEW YORK 10151	
ATTORNEY DOCKET NUMBER:	135428-2226
NAME OF SUBMITTER:	EUGENE LEDONNE
Signature:	/Eugene LeDonne/
Date:	05/08/2014
Total Attachments: 2 source=01431982#page1.tif source=01431982#page2.tif	
<b>RECEIPT INFORMATION</b>  EPAS ID: PAT2847178 Receipt Date: 05/08/2014	

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**A S S I G N M E N T**

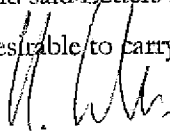
WHEREAS, the undersigned (hereinafter referred to as ASSIGNOR) has invented a certain patent entitled BIOCOMPOSITE AND/OR BIOMATERIAL WITH SUNFLOWER SEED SHELLS/HUSKS which is being filed at the United States Patent and Trademark Office concurrently herewith.

WHEREAS, SPC SUNFLOWER PLASTIC COMPOUND GMBH, having a place of business at Aufm Halskamp 12 48681 Garrel Germany (hereinafter referred to as ASSIGNEE), is desirous of acquiring the entire interest in, to, and under said invention and in, to, and under Letters Patent or similar legal protection to be obtained therefor in the United States and in any and all foreign countries.

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNOR hereby sells, assigns, and transfers to ASSIGNEE the full and exclusive right, title, and interest to said invention in the United States and its territorial possessions, and in all foreign countries, and to all Letters Patent or similar legal protection in the United States and its territorial possessions, and in any and all foreign countries, to be obtained for said invention by any application or any continuation, divisional, renewal, substitute, or reissue thereof, or any legal equivalent thereof in a foreign country, for the full term or terms for which the same may be granted.

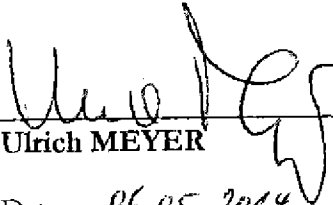
ASSIGNOR HEREBY COVENANTS that no assignment, sale, agreement, or encumbrance has been or will be made or entered into which would conflict with this assignment and sale; and

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention, and said Letters Patent, and legal equivalents in foreign countries, as may be known and accessible to ASSIGNOR and will testify as to the same in any interference or litigation related thereto, and will promptly execute and deliver to ASSIGNEE or its legal representative any and all papers, instruments, or affidavits required to apply for, obtain, maintain, issue, and enforce said application, said invention, and said Letters Patent, and said equivalents thereof in any foreign country, which may be necessary or desirable to carry out the purposes thereof.



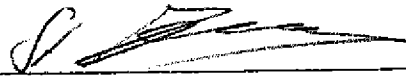
Ulrich WENDELN

Date: 06.05.2014



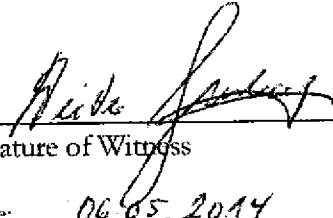
Ulrich MEYER

Date: 06.05.2014



Signature of Witness

Date: 06.05.2014



Signature of Witness

Date: 06.05.2014